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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
09/453,109	12/02/1999	MARK R. PRAUSNITZ	BVTP-P01-539 2183		
28120	7590 12/29/2005		EXAMINER		
FISH & NEAVE IP GROUP			WINAKUR, ERIC FRANK		
ROPES & GR	AY LLP JATIONAL PLACE		ART UNIT	PAPER NUMBER	
	A 02110-2624		3735		

DATE MAILED: 12/29/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

		Applic	ation No.	Applicant(s)				
Office Action Summary		09/45	09/453,109 PRAUSNITZ ET AL.		AL.			
		Exami	ner	Art Unit				
		Eric F.	Winakur	3735				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply								
A SHO WHIC - Exter after - If NO - Failur Any r	ORTENED STATUTORY PERIOD FOR HEVER IS LONGER, FROM THE MISSIONS of time may be available under the provisions SIX (6) MONTHS from the mailing date of this commisting period for reply is specified above, the maximum state to reply within the set or extended period for reply epply received by the Office later than three months and patent term adjustment. See 37 CFR 1.704(b).	AILING DATE OF of 37 CFR 1.136(a). In nunication. Itutory period will apply arwill, by statute, cause the	THIS COMMUNICATION of event, however, may a reply be time and will expire SIX (6) MONTHS from application to become ABANDONE	N. nely filed the mailing date of this o D (35 U.S.C. § 133).				
Status								
2a)□	Responsive to communication(s) file This action is FINAL . Since this application is in condition closed in accordance with the practic	tb)⊠ This action for allowance exc	s non-final. ept for formal matters, pro		e merits is			
Dispositi	on of Claims							
5) □ 6) ⋈ 7) ⋈ 8) □ Applicati 9) □ 10) □	Claim(s) 1-46 is/are pending in the a 4a) Of the above claim(s) is/are Claim(s) is/are allowed. Claim(s) 1-4,6,7,10-12,14-25,27-37. Claim(s) 5,8,9,13,26,38,39,42 and 4 Claim(s) are subject to restrict on Papers The specification is objected to by the The drawing(s) filed on is/are: Applicant may not request that any objected to a series of the specification is objected to by the specification is objected to be specification in the specification is objected to be specification.	re withdrawn from 40,41 and 44-46 is 3 is/are objected to tion and/or election Examiner. a) □ accepted on	s/are rejected. o. on requirement. r b) objected to by the					
	Replacement drawing sheet(s) including The oath or declaration is objected to	the correction is re-	quired if the drawing(s) is ob	jected to. See 37 C	• •			
Priority u	nder 35 U.S.C. § 119							
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 								
Attachment	c(s) e of References Cited (PTO-892)		4) Interview Summary	(PTO.413)				
2) Notice 3) Inform	e of References Cited (PTO-692) e of Draftsperson's Patent Drawing Review (P nation Disclosure Statement(s) (PTO-1449 or r No(s)/Mail Date		Paper No(s)/Mail Do Notice of Informal F	ate	O-152)			

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DETAILED ACTION

1. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claim Rejections - 35 USC § 112

2. Claims 19 and 23 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. The claims merely provide an intended use without properly setting forth further structural limitations.

Claim Rejections - 35 USC § 102

3. Claims 1, 2, 12, 14, 15, 18, 20, 22, 25, 27, 28, 31, 32, 36, 37, 40, 41, and 44 - 46 are rejected under 35 U.S.C. 102(b) as being anticipated by Lin et al. (USPN 5,591,139 - previously cited). Lin et al. teach a microneedle fabricated from silicon wafers using IC processing methods for collecting and analyzing biological samples. The microneedle has a hollow shaft of length from 1 - 6 mm and width of approximately 80 µm connected to an interface region (substrate) that includes a channel (collection chamber) for collecting and sensors for analyzing the fluid. Applicant's attention is drawn to Figures 1A, 2A, 6, 7, and the descriptions of column 3, line 19 - column 4, line 17 and column 9, line 34 - column 10, line 14. Further, resistors, micropumps, and microvalves may be incorporated into the microneedle (column 8, lines 26 - 54), which serve to selectively communicate/transport fluid to the collection area.

Claim Rejections - 35 USC § 103

Claims 1 - 4, 6, 7, 10, 15, 27, 29 - 34, 36, and 40 are rejected under 35 U.S.C. 4. 103(a) as being unpatentable over Yoshihiko (JP 7 - 132119 - previously cited) in view of Lin et al. Yoshihiko teach a sampling device that is fabricated using semiconductor production techniques that includes an array of microneedles connected with a substrate and in fluid communication with a collection chamber (see Figures 1, 3; paragraphs 8, 9, 11, 14 - 16, 18, 20, and 21 of the translation previously submitted). The microneedles of Yoshihiko, as previously noted (see Remarks filed 26 December 2001: 17 June 2002), are 495 µm in length and 30 µm in width. Thus, Yoshihiko teach all of the limitations of the claimed invention except that the length of the microneedles is between 500 µm and 1 mm and that the device/method includes sensors in fluid communication with the microneedles. Lin et al., as described in paragraph 3 above, teach an alternate microneedle arrangement, that, like Yoshihiko is manufactured using semiconductor production techniques. Lin et al. teach that the microneedles can have lengths from 1 mm - 6 mm (determined by control of the semiconductor production techniques) and include sensors to allow real-time analysis of the collected fluids. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the microneedles of Yohsihiko to have lengths as given in Lin et al., since both microneedles are manufactured by semiconductor fabrication techniques and Lin et al. teach that microneedles of 1 mm length can be produced by these techniques, and further, to include sensors in the arrangement, since this allows real-time analysis of the collected fluids.

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Claims 1, 2, 11, 14 - 17, 19 - 21, 23, 24, 27, 28, 30 - 32, 35 - 37, 40, 41, and 44 -5. 46 are rejected under 35 U.S.C. 103(a) as being unpatentable over Smart et al. in view of Lin et al. Smart et al. teach a microsampling device that is constructed using silicon microfabrication technique that includes a microneedle connected with a substrate, and a collection chamber with configurations for performing analysis of the analytes in the collected fluid, including glucose. Smart et al. teach that the microneedle has a width of 30 to 300 µm and a length of about 3 mm. Thus, Smart et al. teach all of the features of the claimed invention except for the particular length of the microneedle set forth in the claim. Lin et al., as described in paragraph 3 above, teach an alternate microneedle arrangement that, like Smart et al. is manufactured using semiconductor production techniques. Lin et al. teach that the microneedles can have lengths from 1 mm - 6 mm (determined by control of the semiconductor production techniques). It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the microneedle of Smart to have lengths as given in Lin et al., since both microneedles are manufactured by semiconductor fabrication techniques and Lin et al. teach that microneedles of 1 mm length can be produced by these techniques. With regard to claim 11, as it is well known to use adhesive to retain medical sensors in contact with a subject during use of the sensor, it would have been obvious to provide the combination with adhesive to maintain the sensor in contact with a subject during a sampling.

Response to Arguments

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6. Applicant's arguments with respect to claims 1 - 4, 6, 7, 10 - 12, 14 - 25, 27 - 37, 40, 41, and 44 - 46 have been considered but are moot in view of the new ground(s) of rejection.

Allowable Subject Matter

- 7. The following is a statement of reasons for the indication of allowable subject matter: The prior art does not teach or suggest a device that includes either: a collection chamber that is a syringe, has a one-way valve, or has a plurality of compartments; a means for controlling flow that is a fracturable or removable barrier; a microneedle having a hollow bore containing a material to modulate the flow of biological fluid; or wherein the microneedle comprises a metal, in combination with the other claimed elements.
- 8. Claims 5, 8, 9, 13, 26, 38, 39, 42, and 43 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Eric F. Winakur whose telephone number is 571/272-4736. The examiner can normally be reached on M-Th, 7:30-5; alternate Fri.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Ali Imam can be reached on 571/272-4737. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Efic F Winakur Primary Examiner Art Unit 3735

23 December 2005